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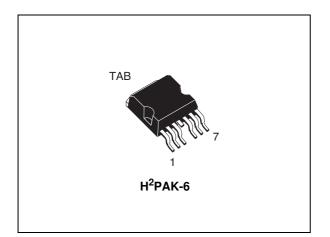




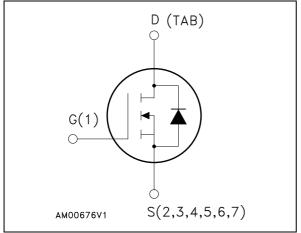
## STH300NH02L-6

Datasheet – production data

# Automotive-grade N-channel 24 V, 0.95 mΩ typ., 180 A STripFET™ III Power MOSFET in a H<sup>2</sup>PAK-6 package



#### Figure 1. Internal schematic diagram



#### Features

Order code	V <sub>DSS</sub>	R <sub>DS(on)</sub> max.	I <sub>D</sub> <sup>(1)</sup>
STH300NH02L-6	24 V	$<$ 1.2 m $\Omega$	180 A

1. Current limited by package.

- Designed for automotive applications and AEC-Q101 qualified
- Conduction losses reduced
- Low profile, very low parasitic inductance, high current package

#### **Applications**

• Switching applications

### Description

This device is an N-channel enhancement mode Power MOSFET produced using STMicroelectronics' STripFET<sup>™</sup> III technology, which is specifically designed to minimize onresistance and gate charge to provide superior switching performance.

#### Table 1. Device summary

Order code	Marking	Package	Packaging
STH300NH02L-6 300NH02L		H <sup>2</sup> PAK-6	Tape and reel

This is information on a product in full production.

## Contents

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## 1 Electrical ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage	24	V
V <sub>GS</sub>	Gate-source voltage	± 20	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	180	А
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 100 °C	180	А
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	720	А
P <sub>TOT</sub> <sup>(3)</sup>	Total dissipation at $T_{C}$ = 25 °C	300	W
	Derating factor	2	W/°C
E <sub>AS</sub> <sup>(4)</sup>	Single pulse avalanche energy	1.6	J
T <sub>stg</sub>	Storage temperature	-55 to 175	ာ
Тj	Operating junction temperature	0010170	Ŭ

Table 2. Absolute maximum rating	S
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1. Current limited by package

2. Pulse width limited by safe operating area

3. This value is rated according to  $\rm R_{\rm thj-c}$ 

4. Starting  $T_j = 25 \text{ °C}$ ,  $I_D = 60 \text{ A}$ ,  $V_{DD} = 20 \text{ V}$ 

#### Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	0.5	°C/W
R <sub>thj-pcb</sub> <sup>(1)</sup>	Thermal resistance junction-pcb max	35	°C/W

1. When mounted on 1 inch2 FR-4 2 oz Cu.



## 2 Electrical characteristics

(Tcase = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage (V <sub>GS</sub> = 0)	I <sub>D</sub> = 250 μA	24			V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	V <sub>DS</sub> = 24 V, V <sub>DS</sub> = 24 V, T <sub>C</sub> =125 °C			1 10	μΑ μΑ
I <sub>GSS</sub>	Gate body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 20 V			± 100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1			V
R <sub>DS(on)</sub>	Static drain-source on- resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 80 A V <sub>GS</sub> = 5 V, I <sub>D</sub> = 40 A		0.95 1.15	1.2 1.5	mΩ

Table	4.	On	/off	states
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Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	7050	-	pF
C <sub>oss</sub>	Output capacitance	V <sub>DS</sub> = 15 V, f = 1 MHz, V <sub>GS</sub> =0	-	3250	-	pF
C <sub>rss</sub>	Reverse transfer capacitance		-	307	-	pF
Qg	Total gate charge	V <sub>DD</sub> = 20 V, I <sub>D</sub> = 120 A,	-	109	-	nC
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> = 10 V	-	30	-	nC
Q <sub>gd</sub>	Gate-drain charge	(see Figure 14)	-	26	-	nC

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 20 \text{ V}, \text{ I}_{D} = 80 \text{ A}$	-	18	-	ns
t <sub>r</sub>	Rise time	R <sub>G</sub> = 4.7 Ω, V <sub>GS</sub> = 10 V, <i>(see Figure 13)</i>	-	275	-	ns
t <sub>d(off)</sub>	Turn-off delay time	V <sub>DD</sub> = 20 V, I <sub>D</sub> = 80 A	-	138	-	ns
t <sub>f</sub>	Fall time	R <sub>G</sub> = 4.7 Ω, V <sub>GS</sub> = 10 V, <i>(see Figure 13)</i>	-	94.4	-	ns



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub> <sup>(1)</sup> I <sub>SD</sub> <sup>(2)</sup>	Source-drain current Source-drain current (pulsed)		-		180 720	A A
V <sub>SD</sub> <sup>(3)</sup>	Forward on voltage	I <sub>SD</sub> = 180 A, V <sub>GS</sub> = 0	-		1.3	V
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 120 A,di/dt = 100 A/µs	-	65		ns
Q <sub>rr</sub>	Reverse recovery charg	V <sub>DD</sub> = 20 V, T <sub>j</sub> = 150 °C	-	90		nC
I <sub>RRM</sub>	Reverse recovery current	(see Figure 15)	-	2.8		А

Table 7. Source drain diode

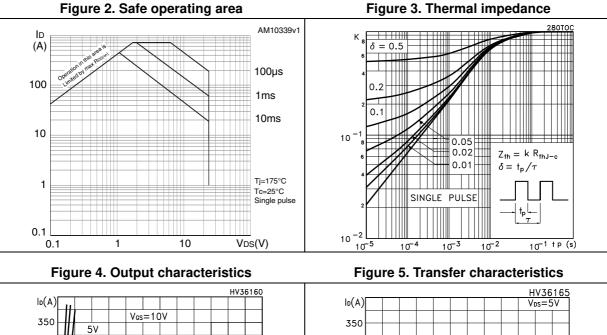
1. Current limited by package

2. Pulse width limited by safe operating area

3. Pulsed: Pulse duration = 300  $\mu$ s, duty cycle 1.5%



#### 2.1 Electrical characteristics (curves)



300

250

200

150

100

50

2

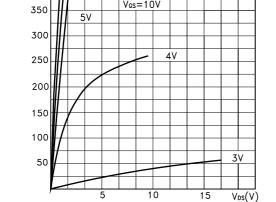


Figure 6. Normalized  $B_{\text{VDSS}}\,\text{vs}$  temperature

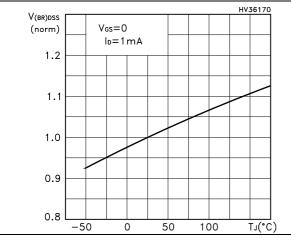


Figure 7. Static drain-source on-resistance

6

8

4

 $10 V_{GS}(V)$ 

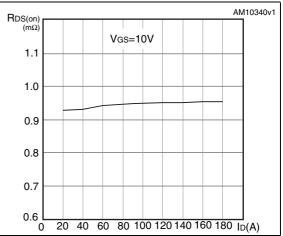




Figure 8. Gate charge vs gate-source voltage

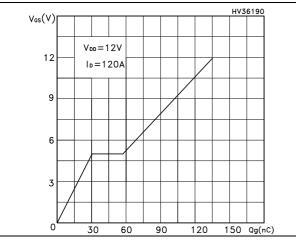


Figure 10. Normalized gate threshold voltage vs temperature

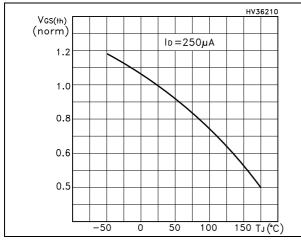


Figure 12. Source-drain diode forward characteristics

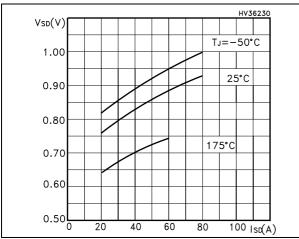


Figure 9. Capacitance variations

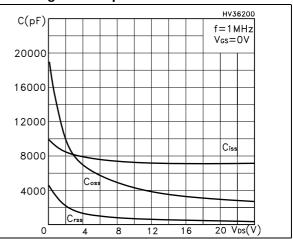
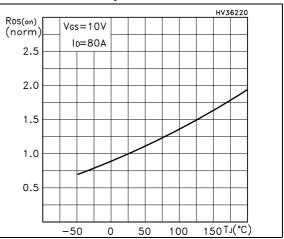


Figure 11. Normalized on resistance vs temperature





### 3 Test circuits

Figure 13. Switching times test circuit for resistive load

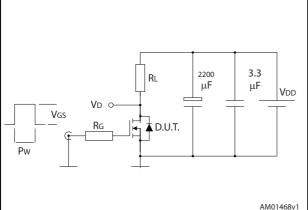


Figure 15. Test circuit for inductive load switching and diode recovery times

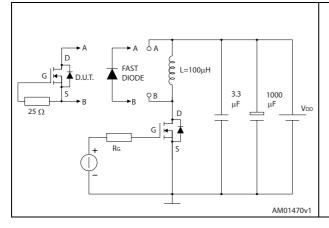
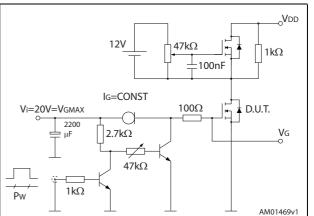
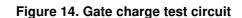
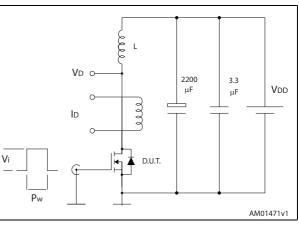


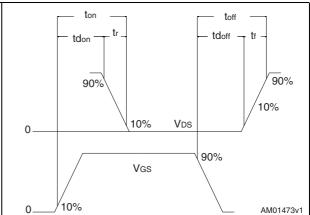
Figure 17. Unclamped inductive waveform

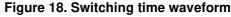


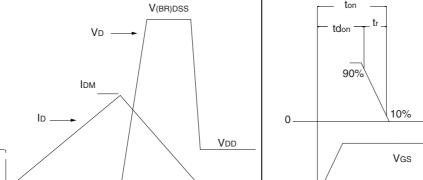












AM01472v1

47/

Vdd

## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

Dim	mm			
Dim.	Min.	Тур.	Max.	
A	4.30		4.80	
A1	0.03		0.20	
С	1.17		1.37	
е	2.34		2.74	
e1	4.88		5.28	
e2	7.42		7.82	
E	0.45		0.60	
F	0.50		0.70	
н	10.00		10.40	
H1	7.40		7.80	
L	14.75		15.25	
L1	1.27		1.40	
L2	4.35		4.95	
L3	6.85		7.25	
L4	1.5	1	1.75	
М	1.90	1	2.50	
R	0.20	1	0.60	
V	0°	1	8°	

Table 8.	H <sup>2</sup> PAK-6	mechanical	data



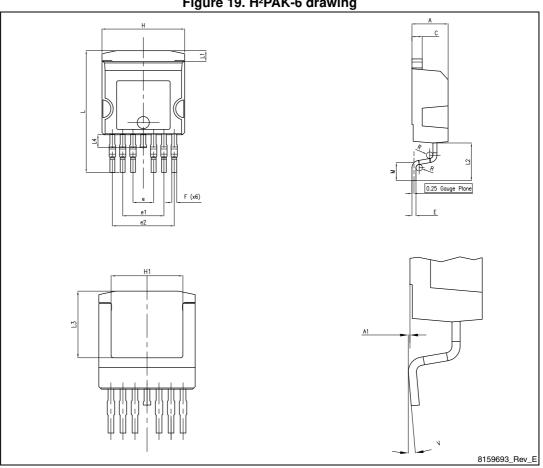
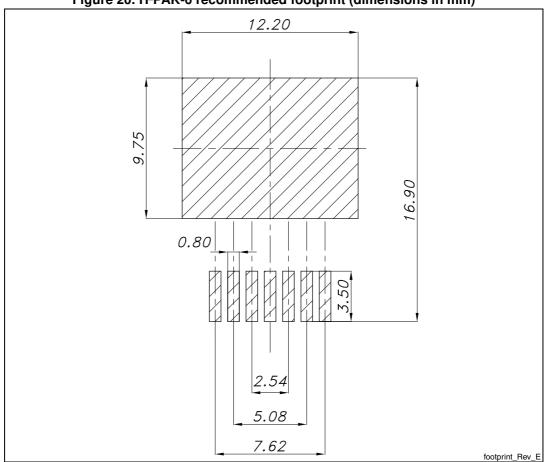


Figure 19. H<sup>2</sup>PAK-6 drawing





#### Figure 20. H<sup>2</sup>PAK-6 recommended footprint (dimensions in mm)



## 5 Packaging mechanical data

Таре				Reel		
Dim	mm		Dim	mm		
	Min.	Max.	— Dim.	Min.	Max.	
A0	10.5	10.7	А		330	
B0	15.7	15.9	В	1.5		
D	1.5	1.6	С	12.8	13.2	
D1	1.59	1.61	D	20.2		
Е	1.65	1.85	G	24.4	26.4	
F	11.4	11.6	Ν	100		
K0	4.8	5.0	Т		30.4	
P0	3.9	4.1				
P1	11.9	12.1		Base qty	1000	
P2	1.9	2.1		Bulk qty	1000	
R	50					
Т	0.25	0.35				
W	23.7	24.3				

Table 9	Tape and	reel	mechanical	data
	Tape and	1661	meenamea	uala





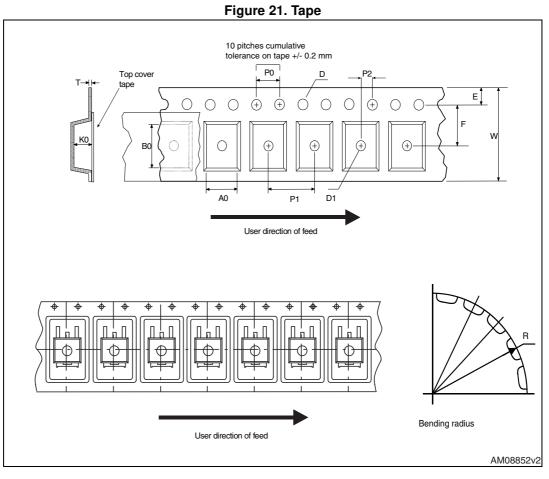
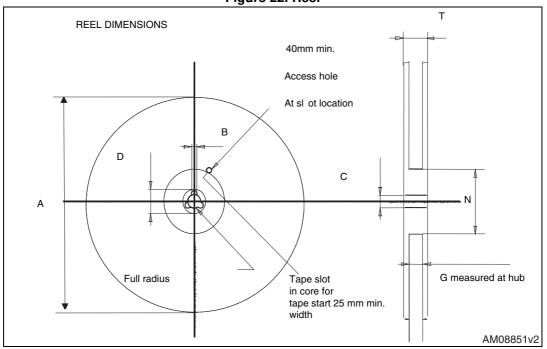


Figure 22. Reel





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## 6 Revision history

Date	Revision	Changes
12-Jul-2011	1	initial release
24-Oct-2011	2	Updated test conditions in <i>Section Table 5.: Dynamic</i> and <i>Section Table 7.: Source drain diode</i> .
15-May-2013	3	<ul> <li>Updated: title, <i>Applications</i> and <i>Description</i> in cover page</li> <li>Minor text changes</li> </ul>
22-Jul-2013	4	<ul> <li>Updated title in cover page.</li> </ul>



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